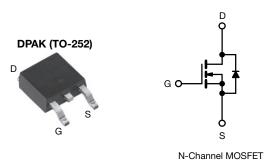
### **Vishay Siliconix**

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PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	6	50
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.60
Q <sub>g</sub> max. (nC)	1	2
Q <sub>gs</sub> (nC)	:	3
Q <sub>gd</sub> (nC)	:	3
Configuration	Sin	igle

# **E Series Power MOSFET**

### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM)  $R_{\text{on}} \, x \, Q_g$
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD690N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V <sub>DS</sub>	600	V
Gate-source voltage			V <sub>GS</sub>	± 30	- V
Continuous drain current (T <sub>.1</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	1-	6.4	
Continuous drain current $(1) = 150^{\circ}$ C)	VGS at TO V	T <sub>C</sub> = 100 °C	ID	4.0	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	11	
Linear derating factor				0.5	W/°C
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	9	mJ
Maximum power dissipation			PD	62.5	W
Operating junction and storage temperature ra	ange		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope		T <sub>J</sub> = 125 °C	dy (dt	70	
Reverse diode dv/dt <sup>d</sup>			dv/dt	17	V/ns
Soldering recommendations (peak temperature	re) c	For 10 s		260	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 0.8 A
- c. 1.6 mm from case
- d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 92273

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	- 62			8044			
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		2.0			°C/W	
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	3.0	-	5.0	V
		, v	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
Zara gata valtaga duain avuvant	V <sub>DS</sub> = 6	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	•	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 2.0 A	-	1.2	-	S
Dynamic		•			•	•	•	•
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	347	-	pF	
Output capacitance	C <sub>oss</sub>			-	24	-		
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-		
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	17	-		
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	86	-		
Total gate charge	Qg				-	8	12	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	$I_{\rm D} = 2.0$	A, V <sub>DS</sub> = 480 V	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	3	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 2.0 A,		-	9	18	1
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	= 10 V, R <sub>g</sub> =	= 9.1 Ω	-	19	38	ns
Fall time	t <sub>f</sub>	]			-	22	44	
Gate input resistance	Rg	f = 1 MHz, open drain		1.1	2.3	4.6	Ω	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	١ <sub>S</sub>	showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.4	
Pulsed diode forward current	I <sub>SM</sub>				-	-	11	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.0 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25$	°C, I <sub>F</sub> = I <sub>S</sub>	= 2.0  A,	-	1.0	2.0	μC
Reverse recovery current	I <sub>RRM</sub>	ai/dt = 1	100 A/µs, \	v <sub>R</sub> = 25 v	-	13	-	A
·····		1			1	-		-

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

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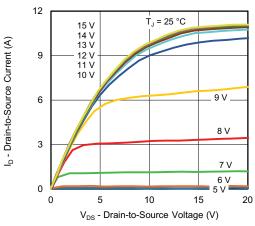


Fig. 1 - Typical Output Characteristics

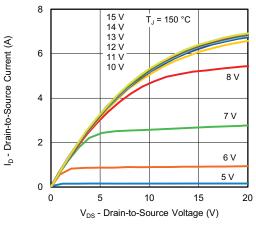


Fig. 2 - Typical Output Characteristics

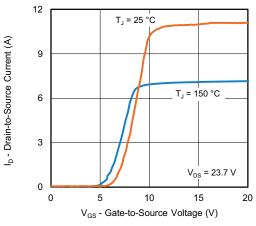


Fig. 3 - Typical Transfer Characteristics

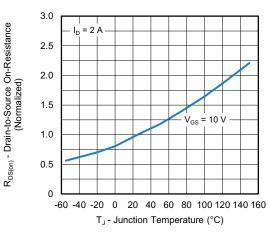


Fig. 4 - Normalized On-Resistance vs. Temperature

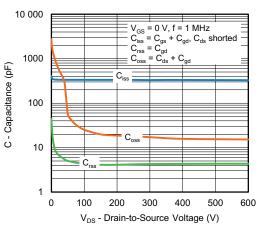
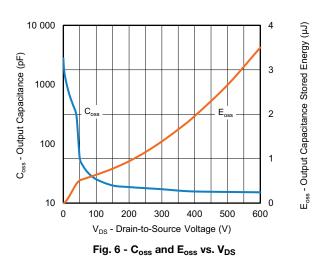


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

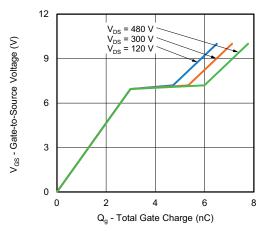


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Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

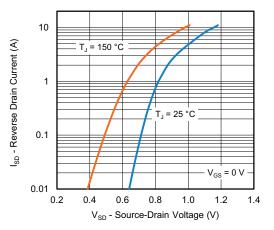


Fig. 8 - Typical Source-Drain Diode Forward Voltage

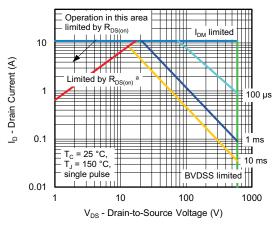


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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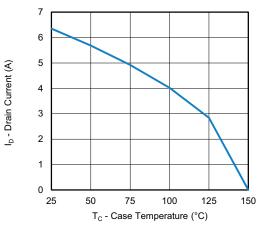


Fig. 10 - Maximum Drain Current vs. Case Temperature

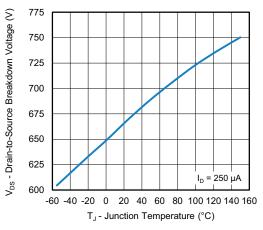
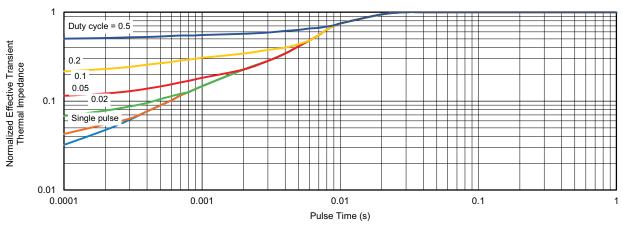
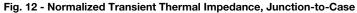


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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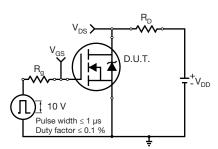


Fig. 13 - Switching Time Test Circuit

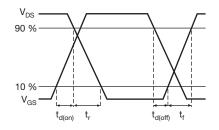


Fig. 14 - Switching Time Waveforms

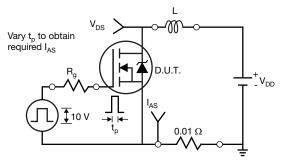
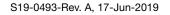


Fig. 15 - Unclamped Inductive Test Circuit



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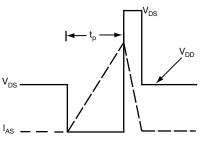


Fig. 16 - Unclamped Inductive Waveforms

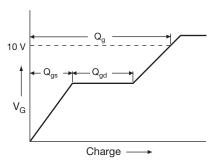
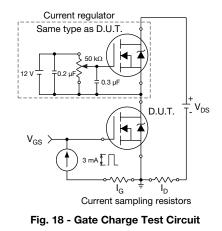


Fig. 17 - Basic Gate Charge Waveform

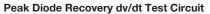




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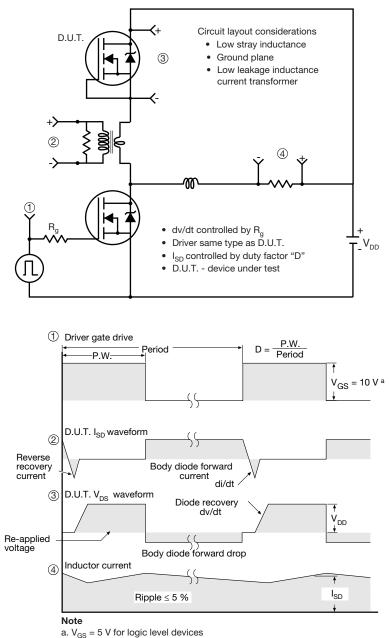


Fig. 19 - For N-Channel

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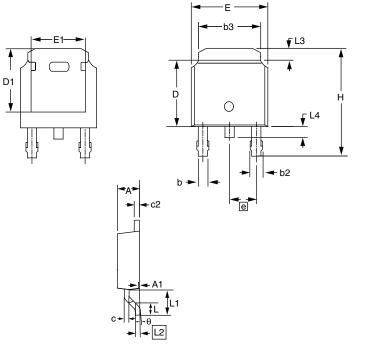
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**Package Information** 

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### **TO-252AA (HIGH VOLTAGE)**



DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
E	6.40	6.73	0.252	0.265	
L	1.40	1.77	0.055	0.070	
L1	2.743 REF		0.108 REF		
L2	0.508 BSC		0.020 BSC		
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.286 BSC		0.090 BSC		
А	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

#### Notes

1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.

2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

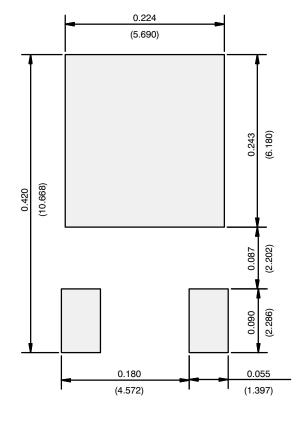
3. The package top may be smaller than the package bottom.

4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.



Vishay Siliconix

### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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